

**General Description**

The 40N20 uses advanced trench technology and design to provide excellent RDS(ON). This device is ideal for PWM, load switching and general purpose applications.

**Product Summary**

BVDSS	RDS(ON)	ID
200V	60mΩ	40A

**Applications**

- DC-DC Converters
- Power switching application

**TO-252/251 Pin Configuration****Features**

- Low On-Resistance
- High Reliability Capability with Passivation
- 100% avalanche tested
- RoHS Compliant

**Absolute Maximum Ratings**

Type	Package	Marking
CMD40N20	TO-252	CMD40N20
CMU40N20	TO-251	CMU40N20

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	200	V
$V_{GS}$	Gate-Source Voltage	$\pm 25$	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current	40	A
$I_D @ T_c = 100^\circ C$	Continuous Drain Current	32	A
$I_{DM}$	Pulsed Drain Current	120	A
EAS	Single Pulse Avalanche Energy <sup>1</sup>	358	mJ
$P_D @ T_c = 25^\circ C$	Total Power Dissipation	135	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction -Case	---	1.2	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$  , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	200	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=20\text{A}$	---	---	60	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D =250\mu\text{A}$	3	---	5	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=200\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}= \pm 25\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_D=15\text{A}$	---	18	---	S
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	2.7	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=100\text{V},V_{\text{GS}}=10\text{V}$ , $I_D=20\text{A}$	---	26	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	11	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	7	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}}=100\text{V},V_{\text{GS}}=10\text{V}$ , $R_L =7.5\Omega$	---	8	---	ns
$T_r$	Rise Time		---	10	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time		---	26	---	
$T_f$	Fall Time		---	6	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	2500	---	pF
$C_{\text{oss}}$	Output Capacitance		---	200	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	100	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	40	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=28\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.2	V

Note :

1.The test condition is  $V_{\text{DD}}=50\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $L=0.5\text{mH}$ , $I_d=42\text{A}$ 

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